

/2.0.0 GaAs MMIC Low Noise Amplifier 0.1-4.5GHz

Features

Single Biasing Voltage (Self Biased)

• Frequency: 0.1-4.5GHz

Small Signal Gain: 31dB Typical
Gain Flatness: ±0.5dB Typical
Noise Figure:0.7dB Typical

• P1dB: 19dBm Typical

• Power Supply: +5V@125mA

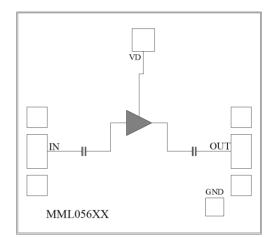
• Input/Output: 50Ω

• Chip Size: 1.08 x 0.98 x 0.1mm

Typical Applications

- Test Instrumentation
- Microwave Radio & VSAT
- Military & Space
- Telecom Infrastructure
- Fiber Optics

Functional Block Diagram



Electrical Specifications

TA = +25°C, VD = +5V, IDD = 125mA Typical

Parameters	Min.	Тур.	Max.	Units
Frequency	0.1		4.5	GHz
Small Signal Gain	30	31		dB
Gain Flatness		±0.5		dB
Noise Figure		0.7		dB
P1dB - Output 1dB Compression	18	19		dBm
Psat - Saturated Output Power		21		dBm
OIP3 - Output Third Order Intercept		29		dBm
Input Return Loss		-10		dB
Output Return Loss		-13		dB

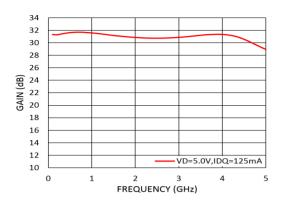
MILLER MMIC INC. www.millermmic.com

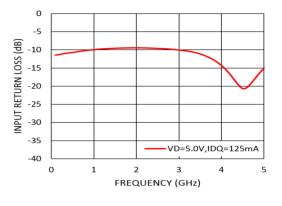
Sales: sales@millermmic.com

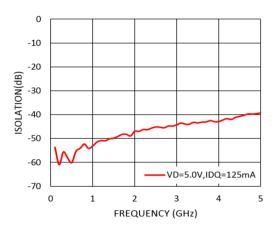


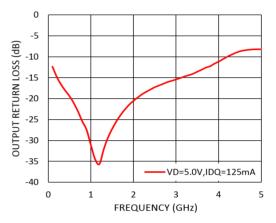
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Measurement Plots: S-parameters

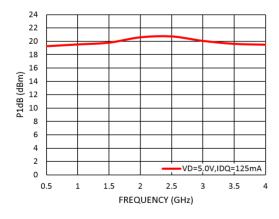




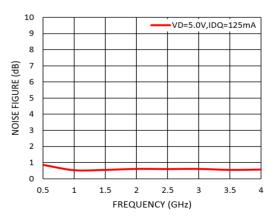




Measurement Plots: P1dB



Measurement Plots: Noise Figure



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Absolute Maximum Ratings

Drain Bias Voltage (VD)	+7V
RF Input Power (RFIN)	+18dBm
Channel Temperature	165°C
Continuous Pdiss (T = 85 °C) (derate 10.6mW/°C above 85 °C)	0.95W
Thermal Resistance (channel to die bottom)	50°C/W
Operating Temperature	-55°C to +85 °C
Storage Temperature	-65°C to +150 °C

Typical Supply Current vs. VD

VD (V)	IDD (mA)
+5	125



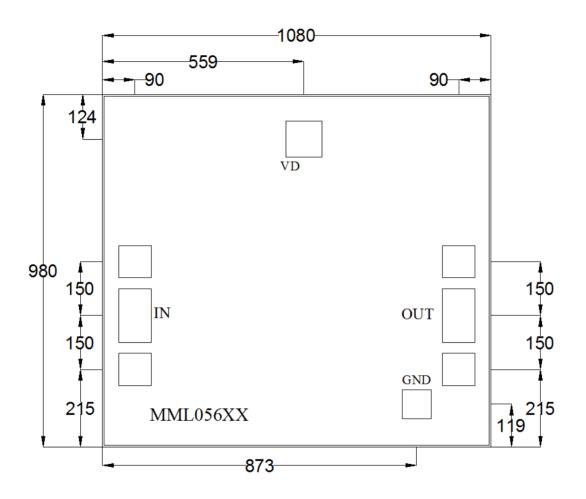
ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS



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Outline Drawing:

All Dimensions in µm



Notes:

1. Die thickness: 100µm

2. DC bond pad is 100*100µm²

3. RF IN/OUT bond pad is 90*150µm²

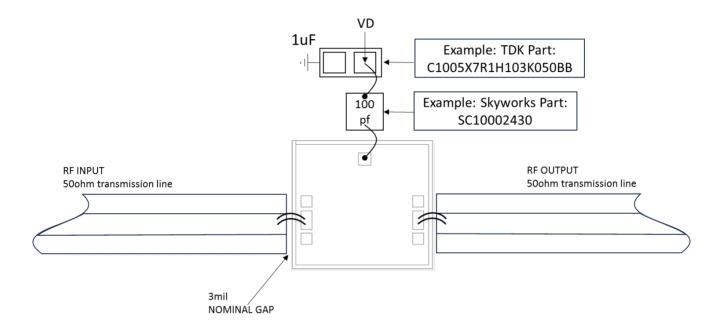
4. Bond pad metalization: Gold

5. Backside metalization: Gold



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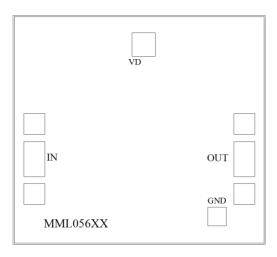
Assembly Drawing



No	Function	Description
1	RF IN	RF Signal Input. This pad is ac-coupled and matched to 50 Ω .
2	RF OUT	RF Signal Output. This pad is ac-coupled and matched to 50 Ω .
3	VD	Drain Biases for the Amplifier. Connect to external 100pf and 1uf bypass capacitors.
4	Die Bottom	Die bottom must be connected to RF and dc ground.



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Biasing and Operation

Turn ON procedure:

- 1. Connect GND to RF and dc ground.
- 2. Apply positive drain voltage VD and set to +5V.
- 3. Apply RF signal.

Turn OFF procedure:

- 1. Turn off the RF signal.
- 2. Turn off the positive drain voltage VD.

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